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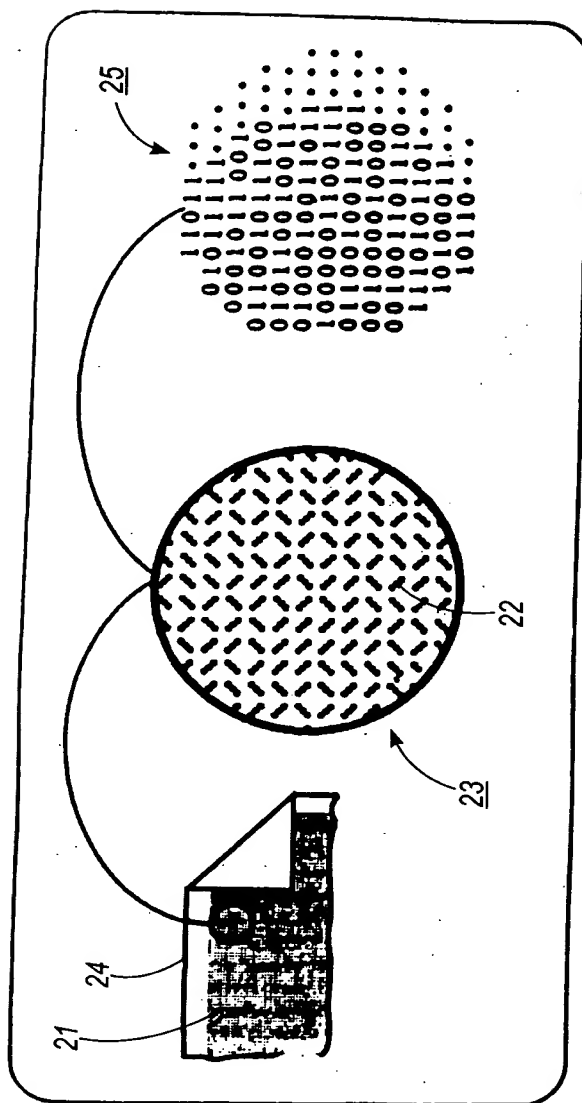


FIG. 1

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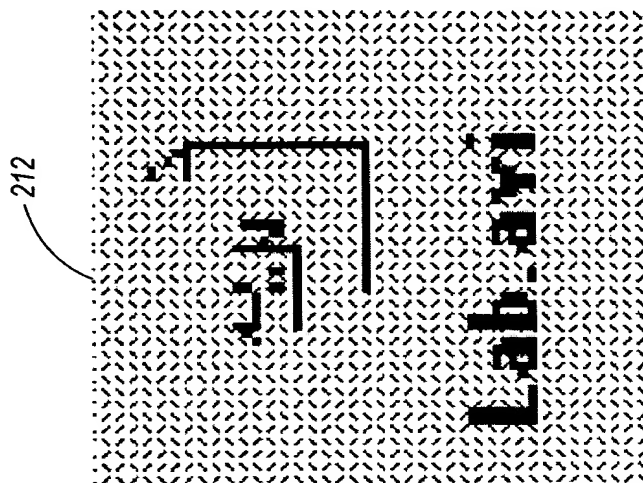


FIG. 3

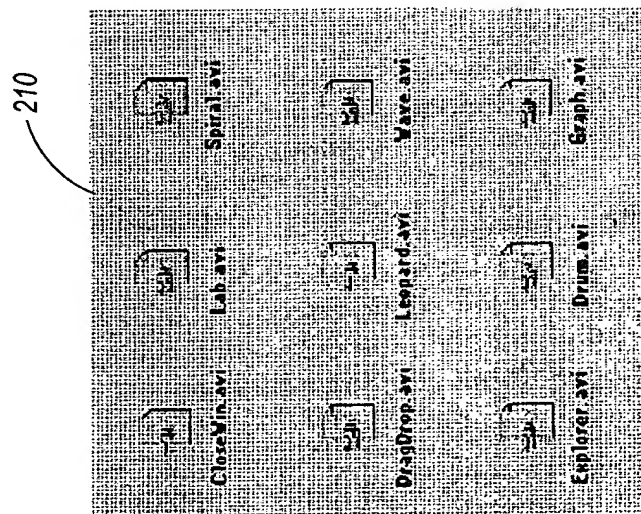


FIG. 2

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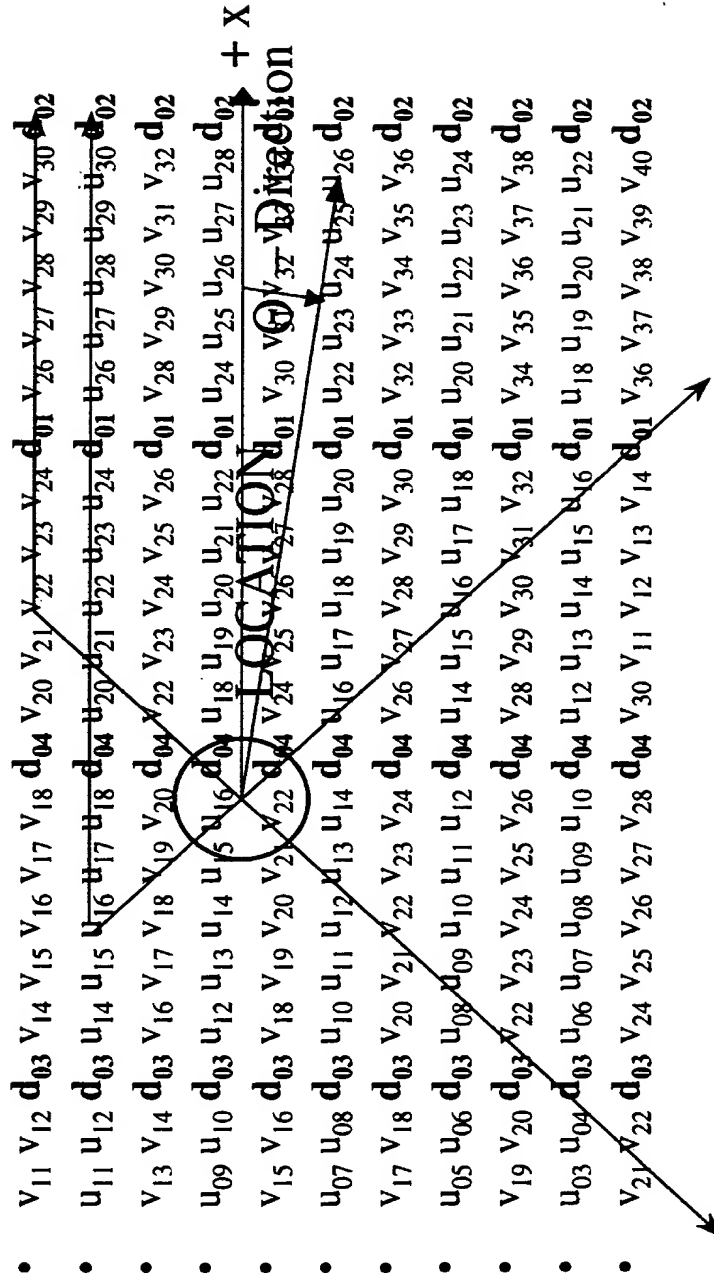


FIG. 4

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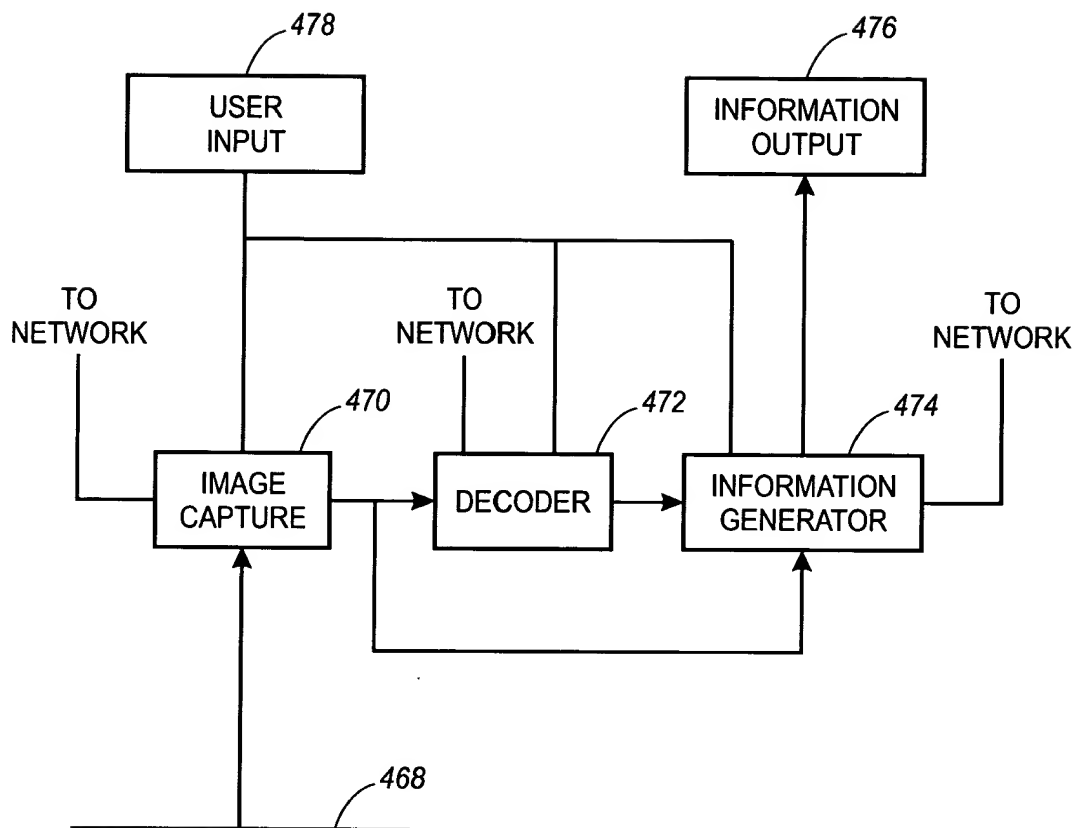


FIG. 5

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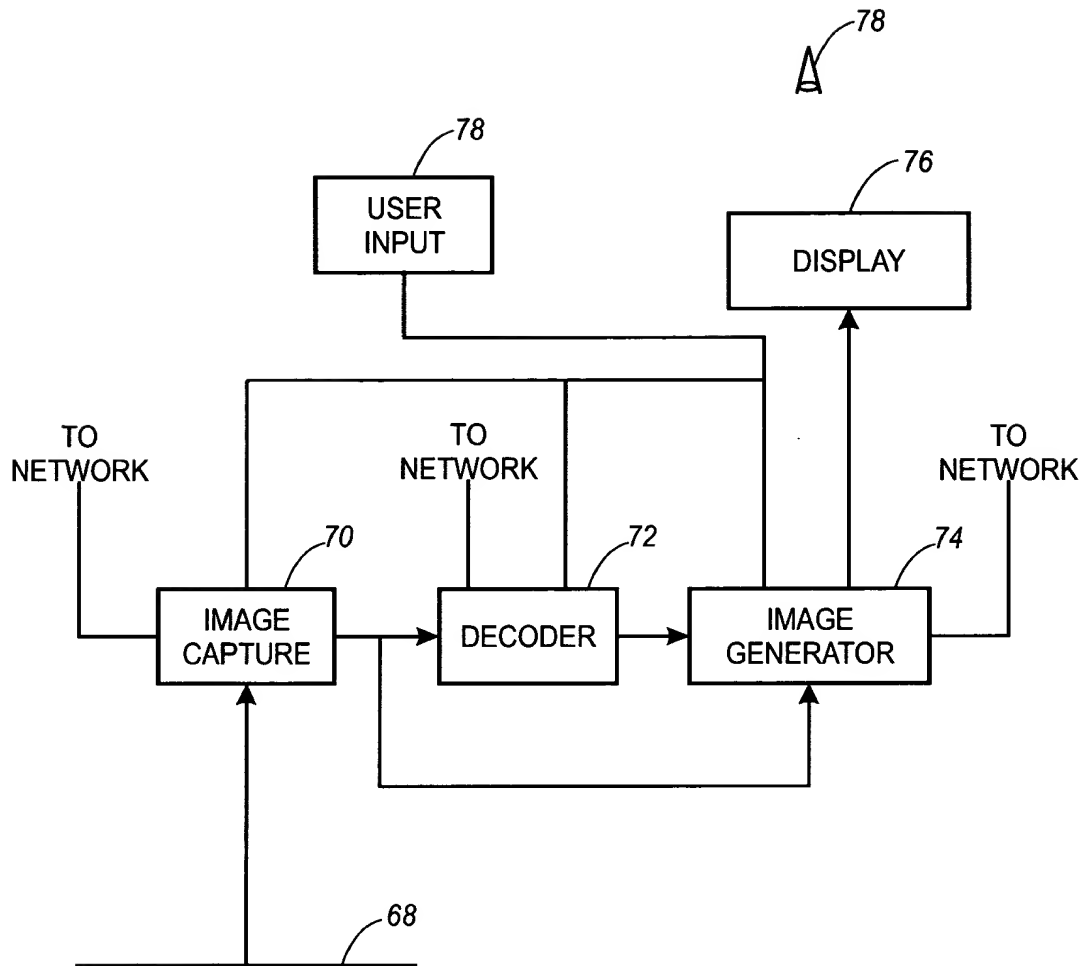


FIG. 6

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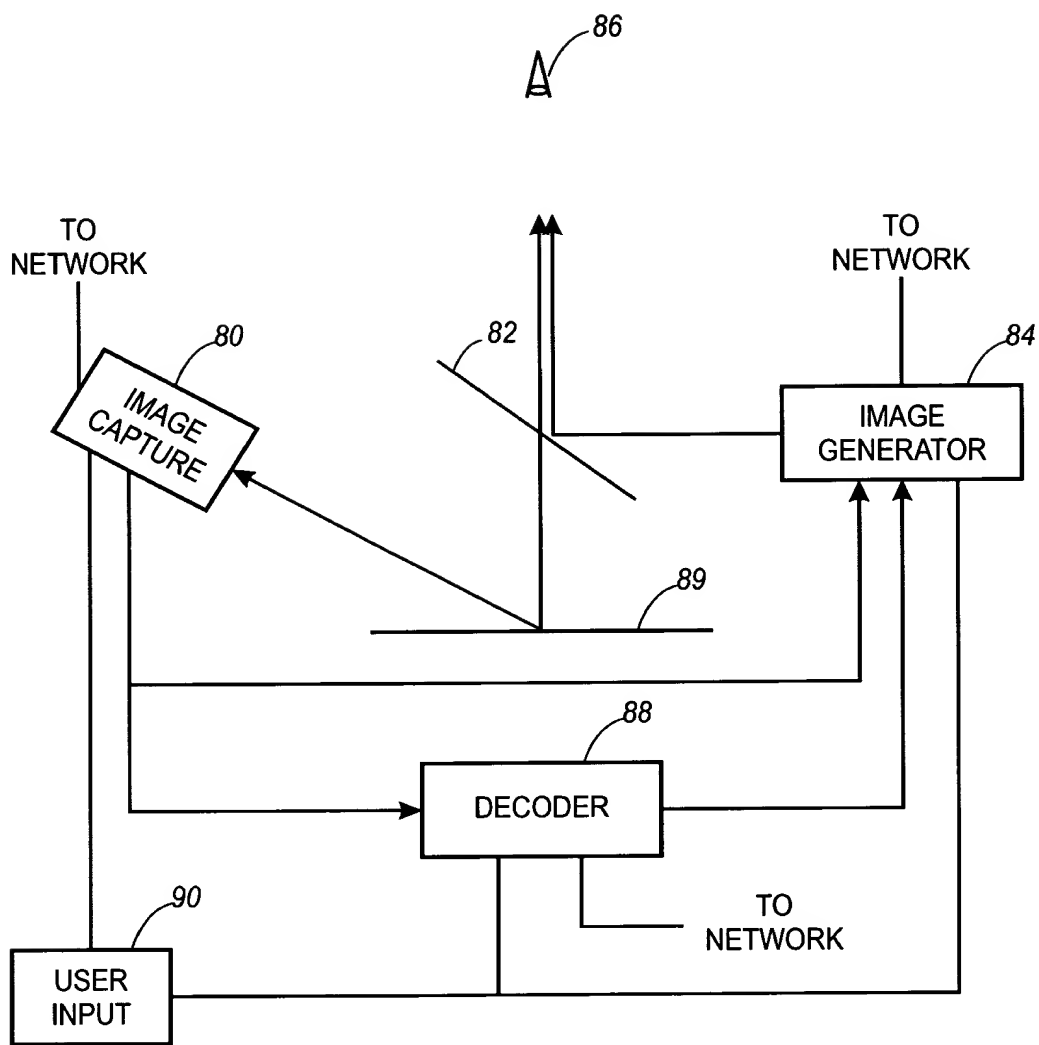


FIG. 7

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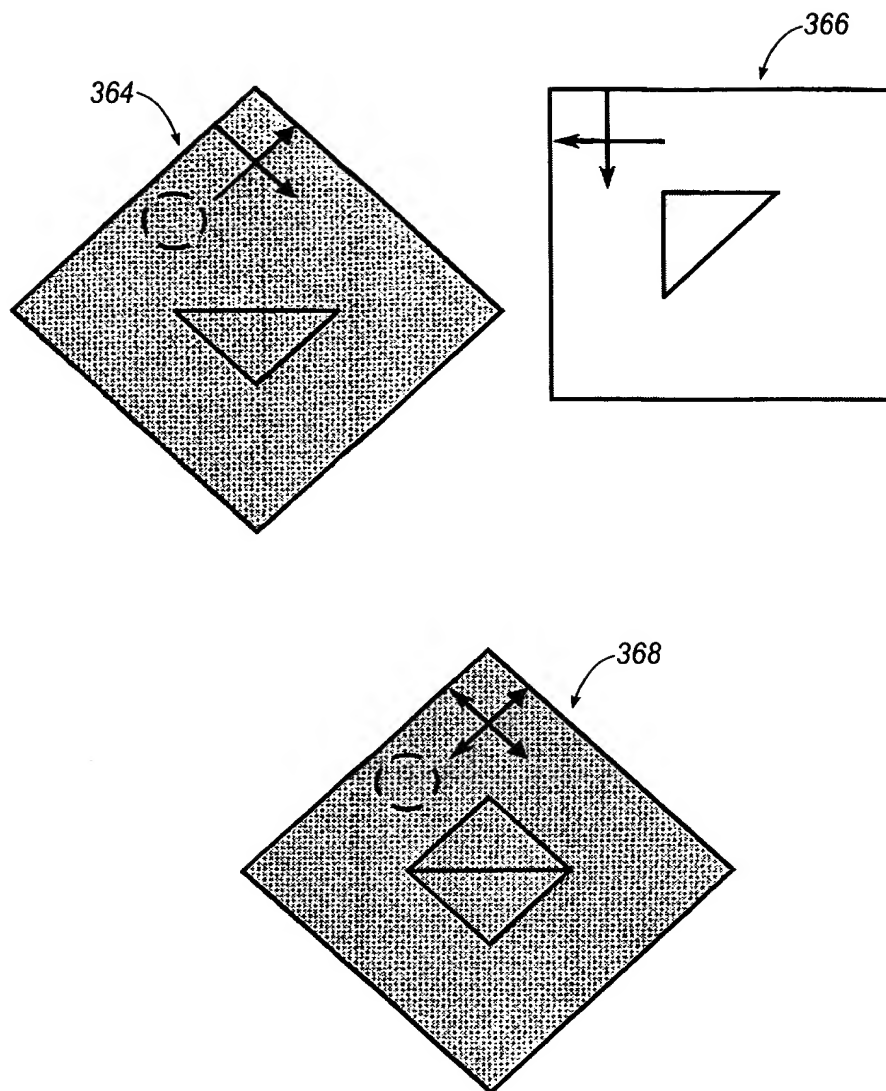


FIG. 8

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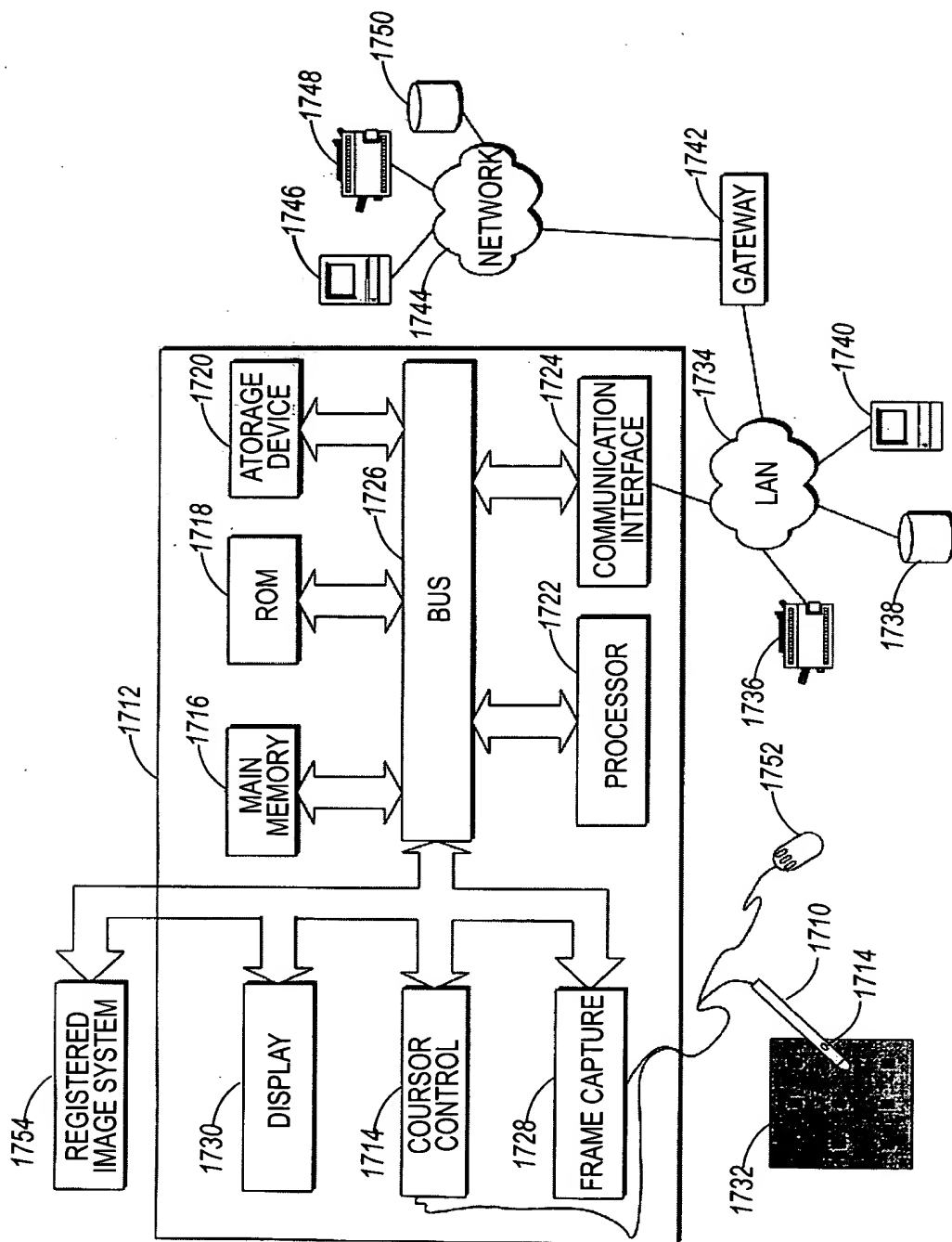


FIG. 9

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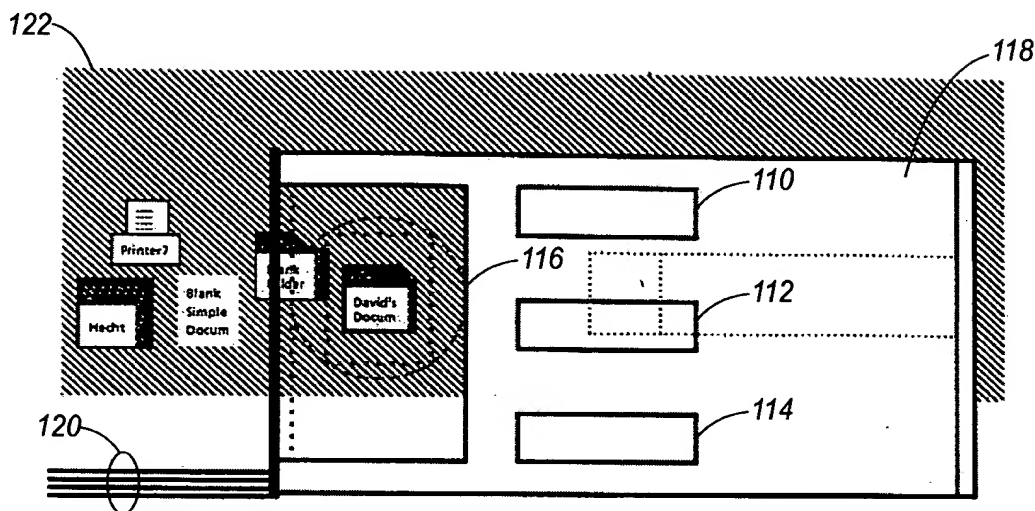


FIG. 10

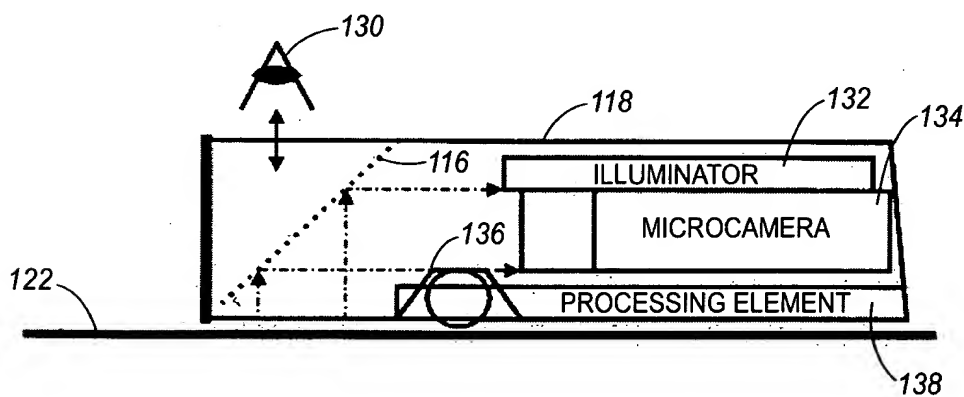


FIG. 11

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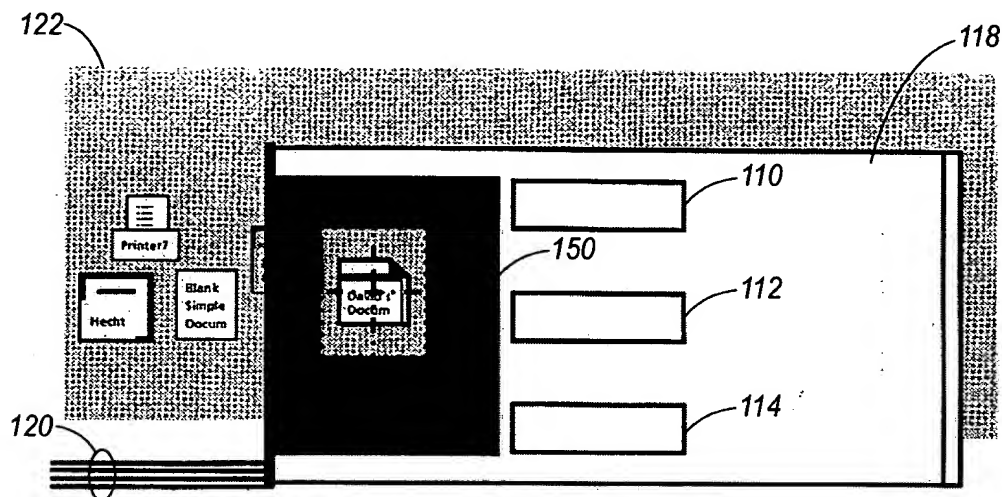


FIG. 12

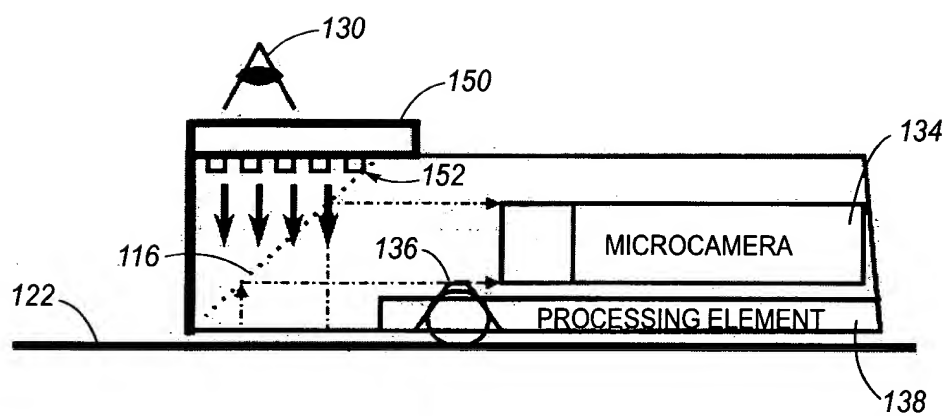
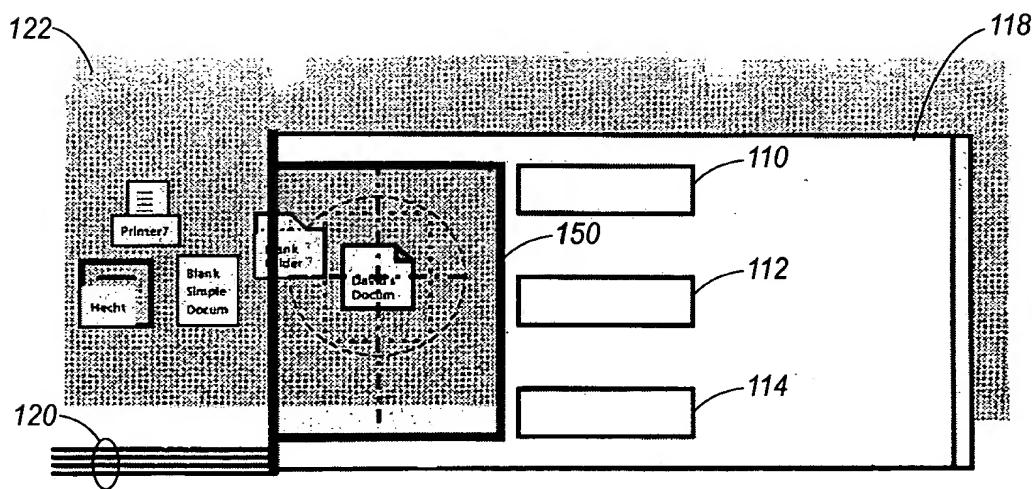
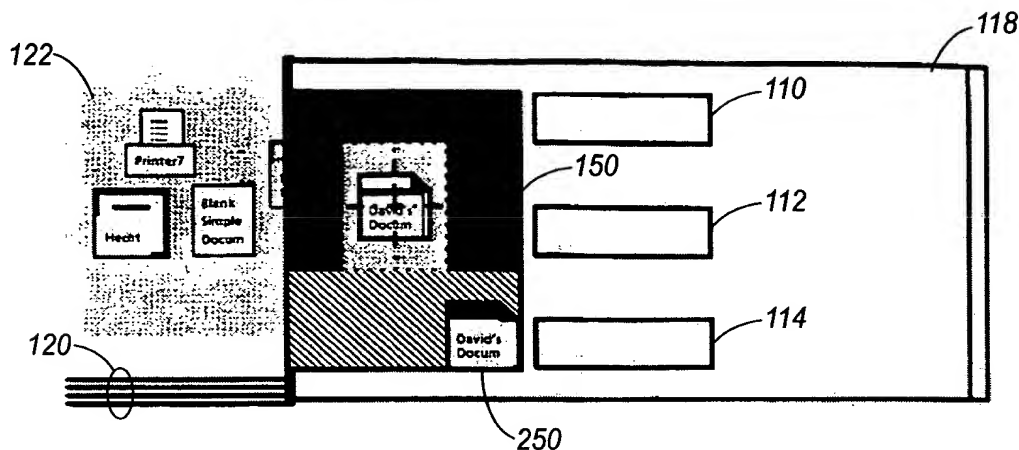


FIG. 13

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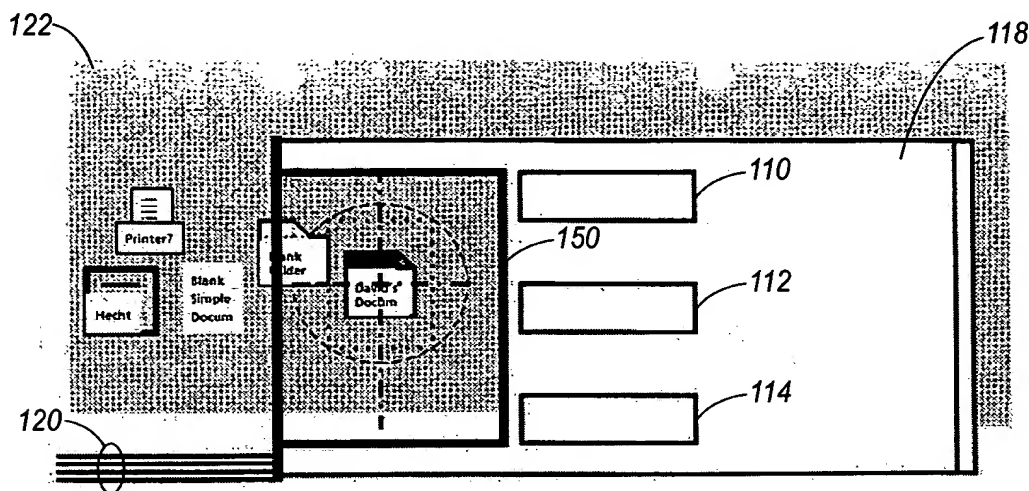


FIG. 16

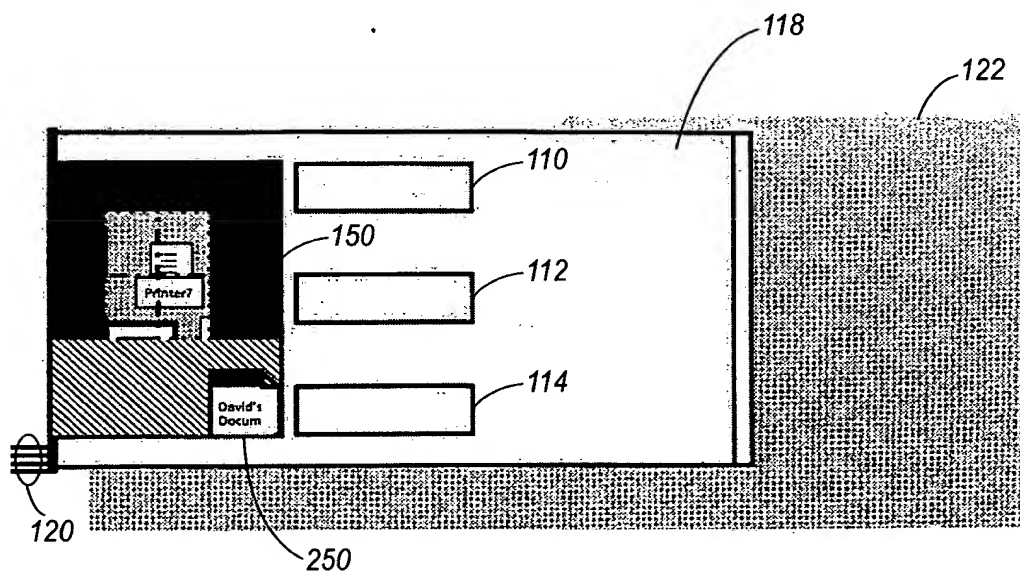


FIG. 17

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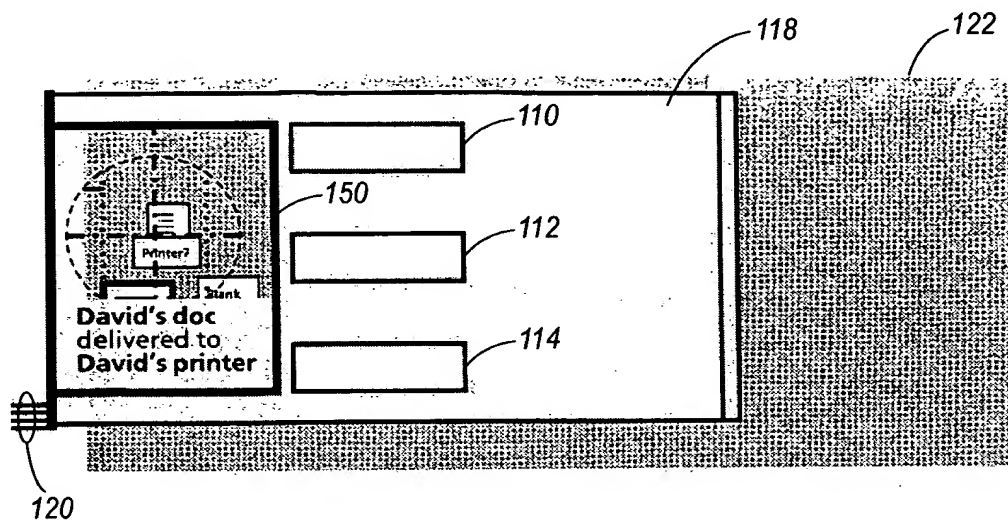


FIG. 18

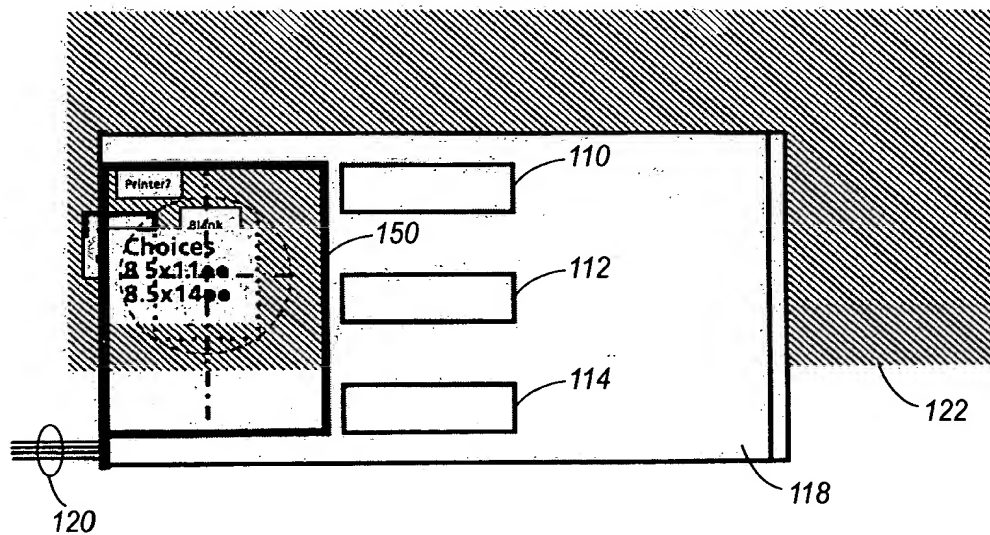


FIG. 19

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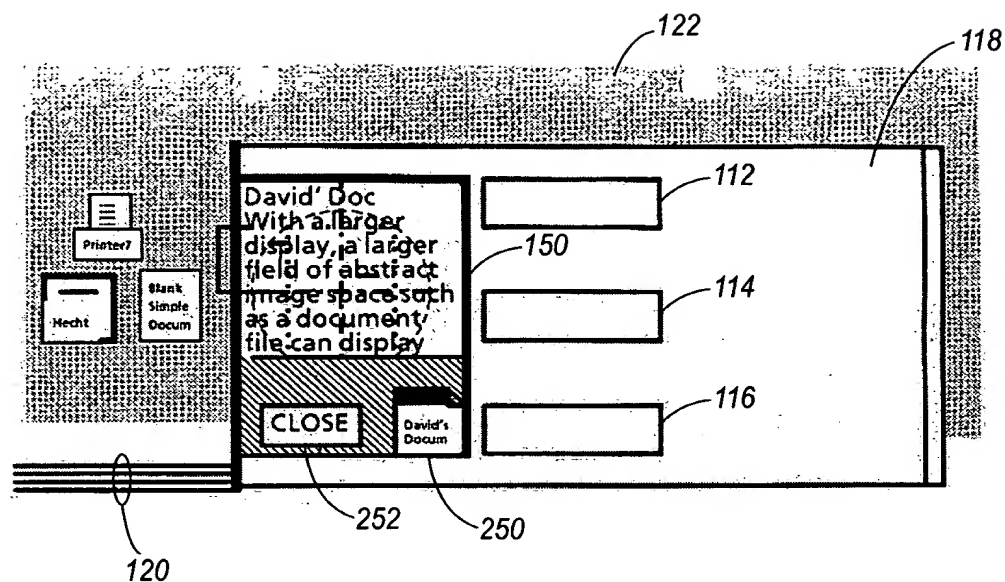


FIG. 20

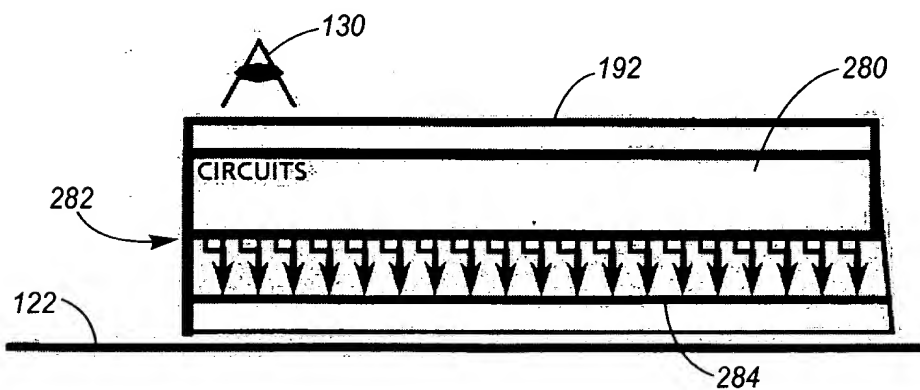


FIG. 23

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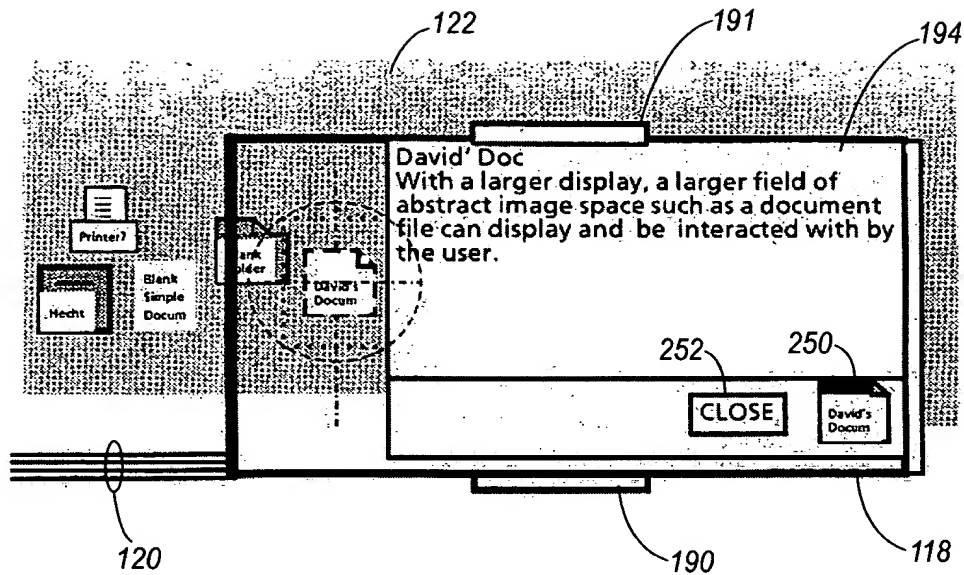


FIG. 21

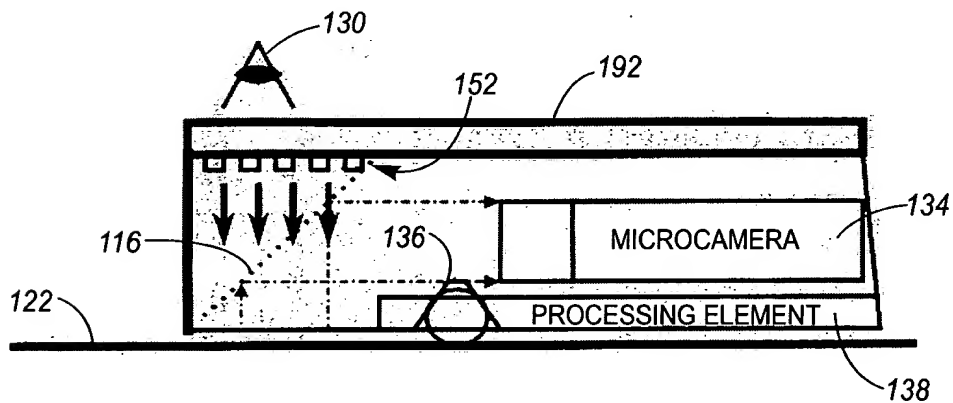


FIG. 22

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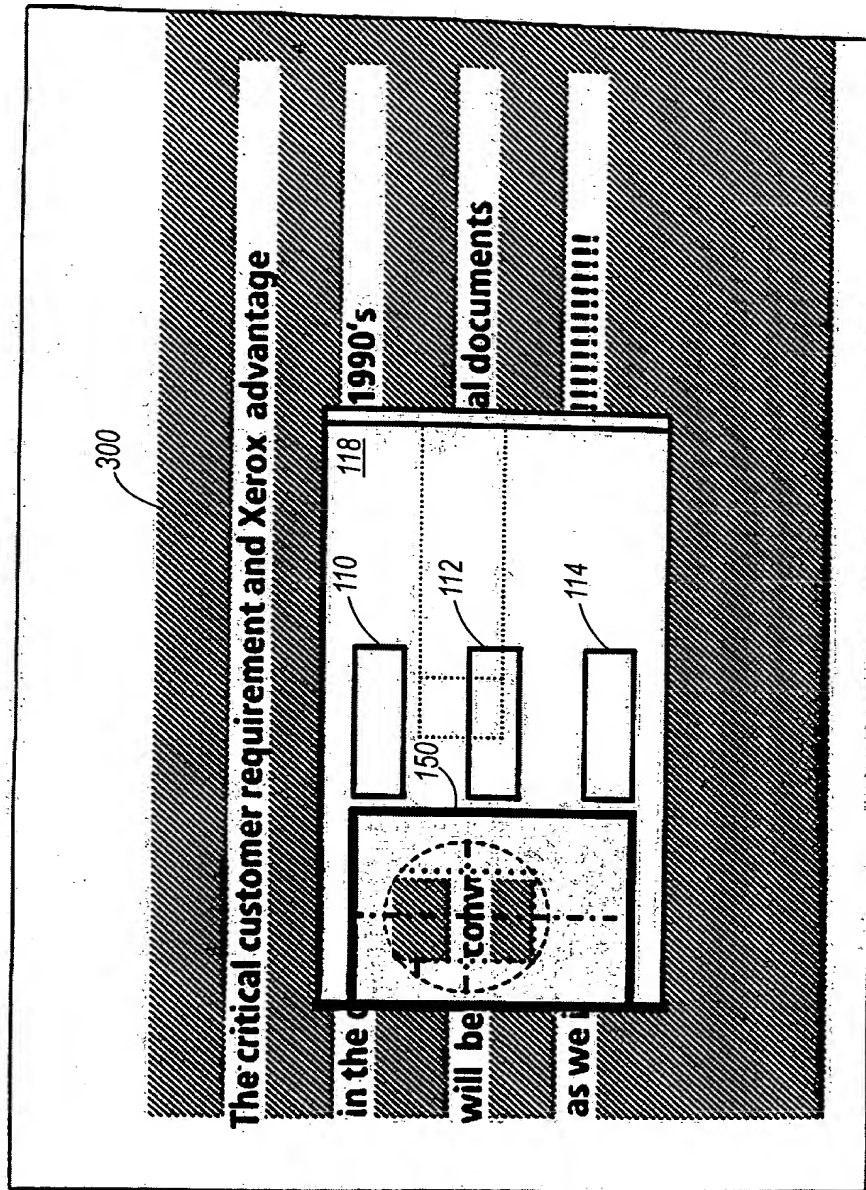


FIG. 24

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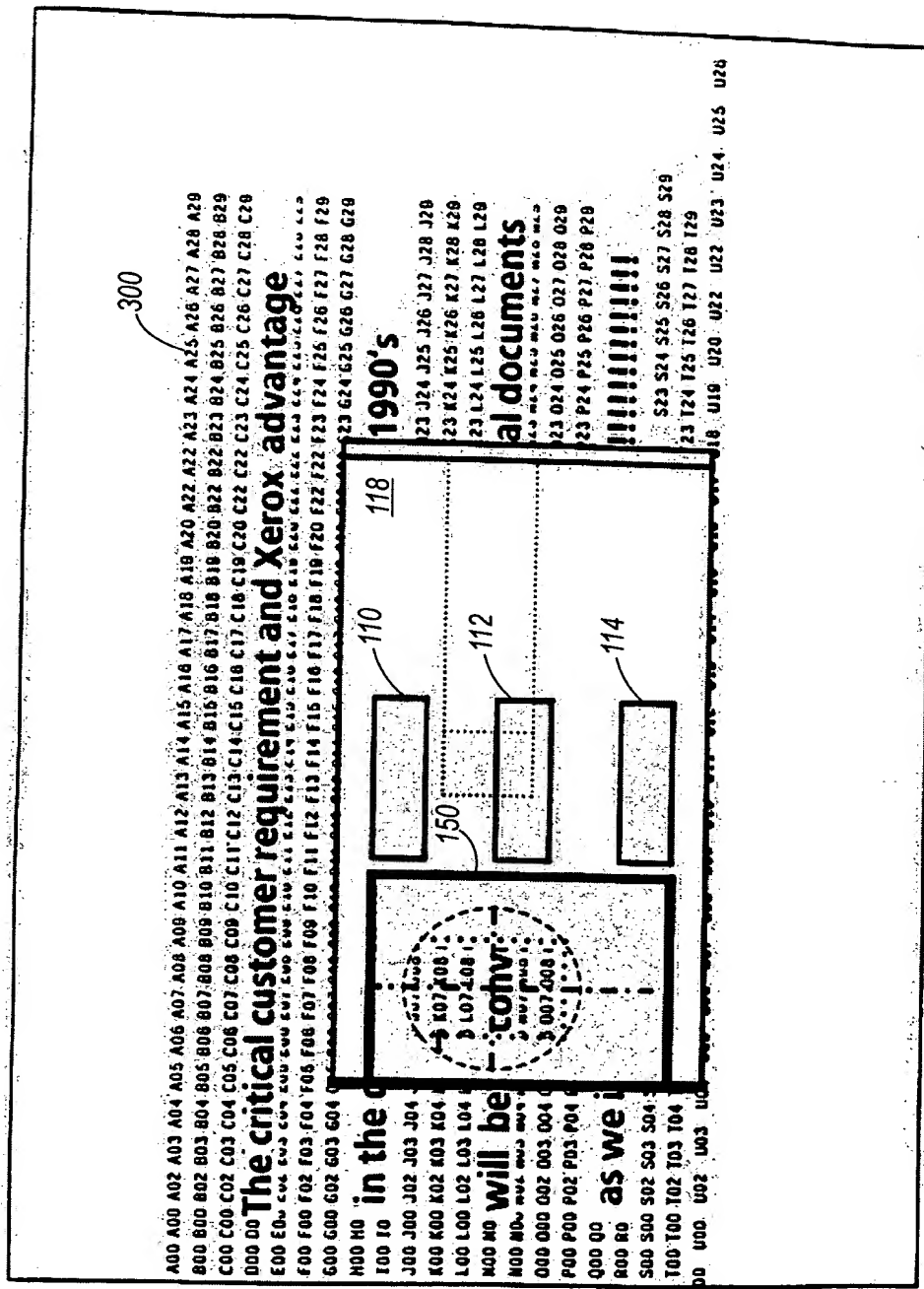


FIG. 25

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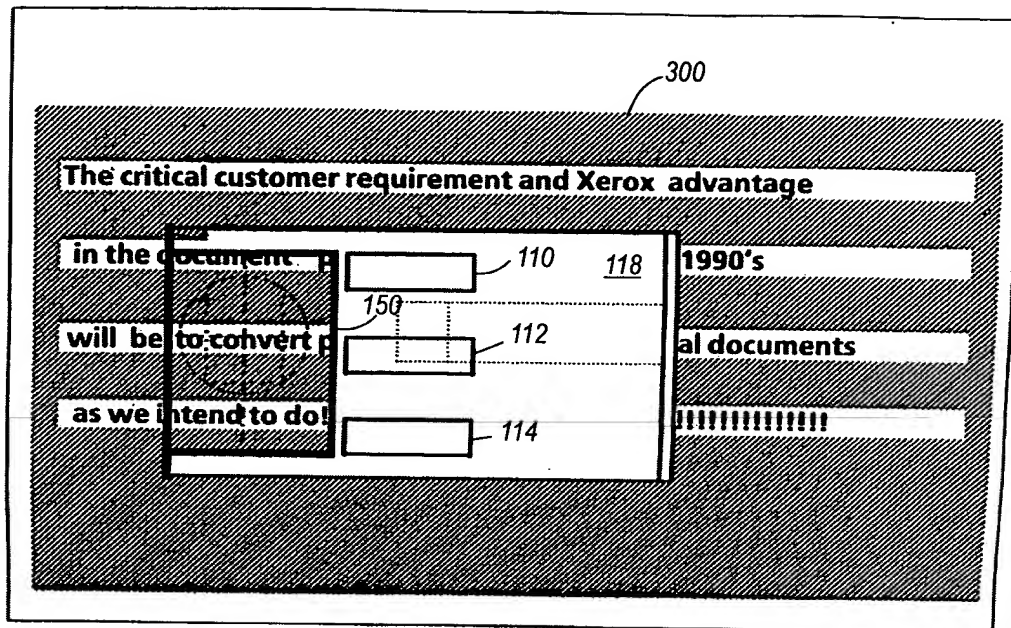


FIG. 26

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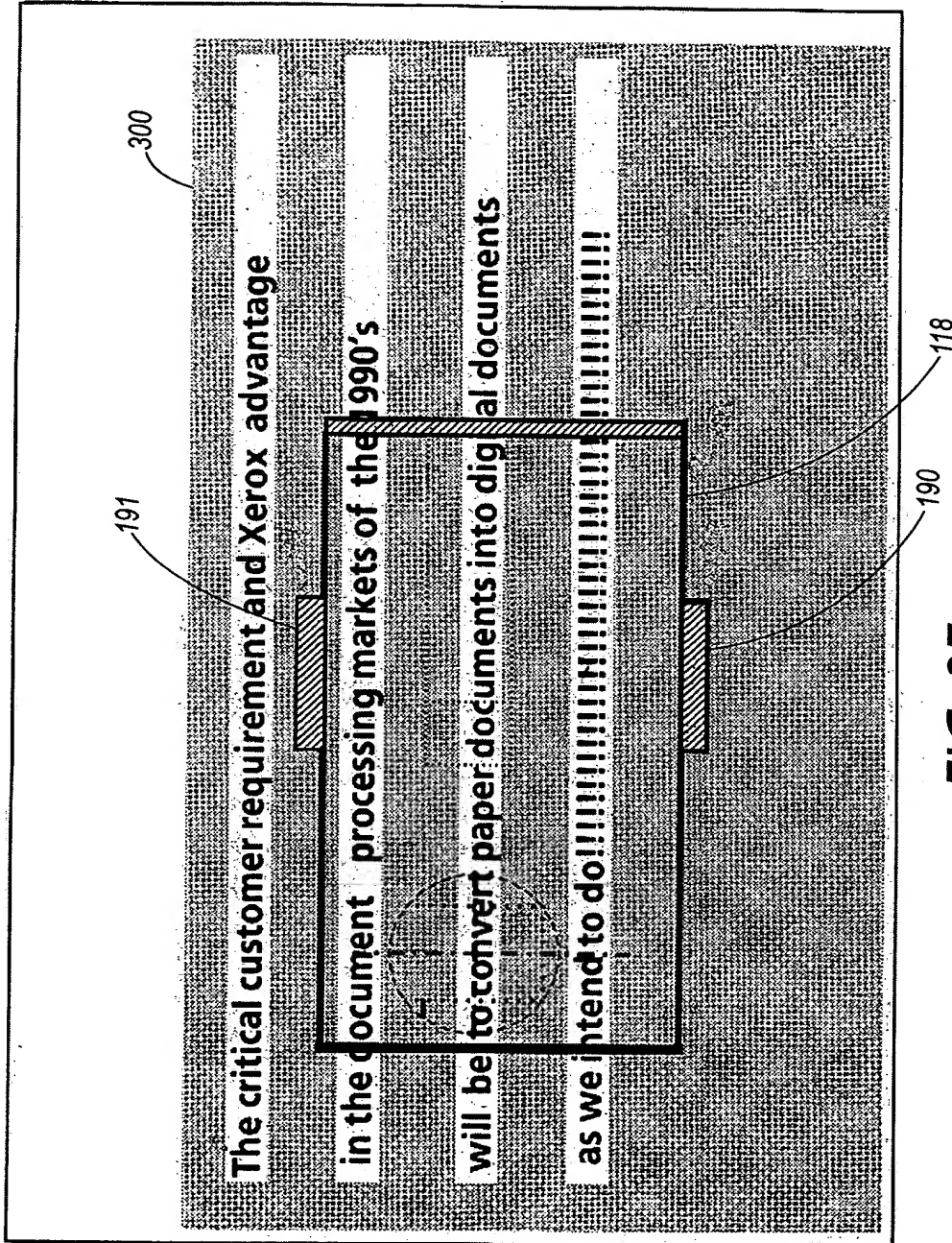


FIG. 27

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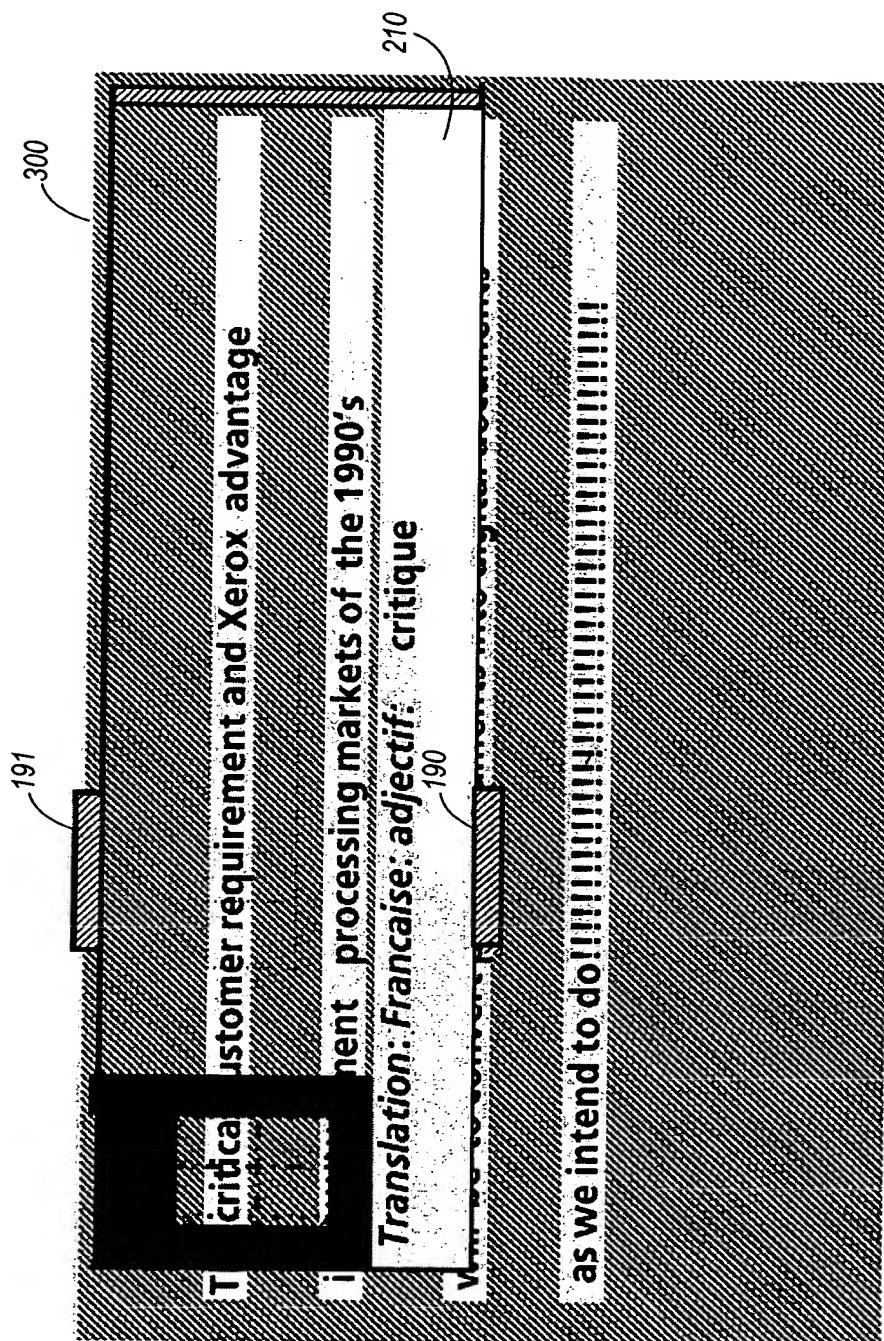
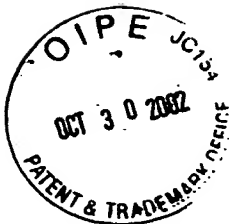


FIG. 28

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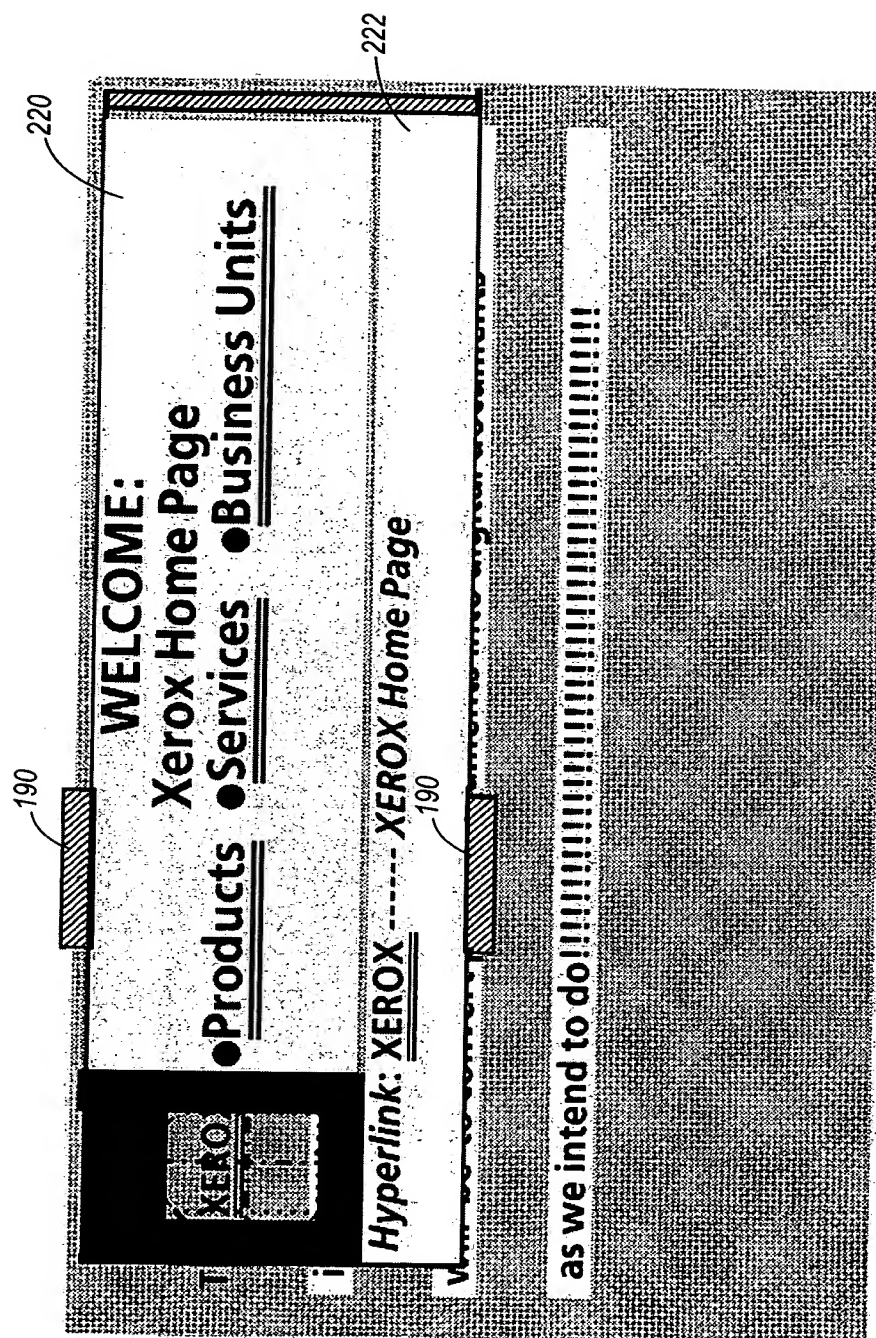


FIG. 29

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